



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Kumi OKADA et al.  
Appl. No. : 10/800,706  
Filed : March 16, 2004  
For : FACSIMILE MACHINE AND COMMUNICATION RESULT  
NOTIFYING METHOD  
Group Art Unit : 2626  
Examiner : Not Yet Assigned  
Confirmation No. : 1757

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
U.S. Patent and Trademark Office  
220 20th Street S.  
Customer Window, Mail Stop \_\_\_\_\_  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, VA 22202

Sir :

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98 and supplemental to the Information Disclosure Statement that was filed on June 23, 2004, Applicants hereby submit a copy of a Notice of Reasons for Rejection that was mailed on August 10, 2004, with respect to patent family member Japanese Patent Application No. 2002-162079, in which the following documents were cited:

- (1) Japanese Laid-Open Patent Publication No. HEI 8-130554, which was published on May 21, 1996;
- (2) Japanese Laid-Open Patent Publication No. HEI 9-054731, which was published on February 25, 1997, together with an English language Abstract of the same;
- (3) Japanese Laid-Open Patent Publication No. HEI 5-002541, which was published on January 8, 1993;

(4) Japanese Laid-Open Patent Publication No. HEI 6-077994, which was published on March 18, 1994, together with an English language Abstract of the same; and

(5) Japanese Laid-Open Patent Publication No. HEI 7-175603, which was published on July 14, 1995, together with an English language Abstract of the same.

The relevance and claims to which each document is relevant, as ascertained by the Japanese Examiner applying Japanese rules to the Japanese claims are set forth in the Notice of Reasons for Rejection.

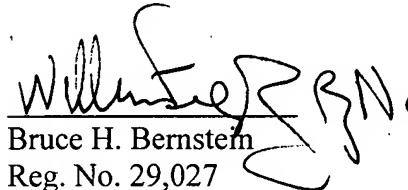
Applicants respectfully request that the Examiner consider the above material and cite the same. Applicants note that documents (1) and (3) were previously cited in a previous Information Disclosure Statement, and thus copies are not attached hereto. Copies of documents (2), (4), and (5) are attached hereto and all of the documents are listed on the attached PTO-1449 Form. The Examiner is requested to initial the appropriate spaces on the attached Form and to return a copy of the completed Form to Applicants with the next official communication in the present application.

Since an Office Action has not yet issued, consideration is appropriate and is respectfully requested.

Furthermore, to the extent necessary, Applicants certify that documents (2), (4), and (5) were first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the Information Disclosure Statement, and thus no fee is required to ensure consideration of the submitted material.

Should the Examiner have any questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully Submitted,  
Kumi OKADA et al.

  
Bruce H. Bernstein  
Reg. No. 29,027

September 1, 2004  
GREENBLUM & BERNSTEIN, P.L.C.  
1950 Roland Clarke Place  
Reston, VA 20191  
(703) 716-1191

**EXAMINER**

---

**DATE CONSIDERED**

\*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

**BEST AVAILABLE COPY**

**NOTICE OF REASONS FOR REJECTION**

SEP 01 2004

01 SEP  
JAPANESE PATENT OFFICE  
2004

Dispatch Date : August 10, 2004

Japanese Patent Application Number : No. 2002-162079

Drafting Date : August 3, 2004

Examiner of Patent Office : Shinichi YAMAZAKI

Attorney : Kimihito WASHIDA

Applied Provisions : Section 29(2) and Section 29<sup>bis</sup>

This application should be refused for the reason mentioned below. If the applicant has any argument against the reason, such argument should be submitted within 60 days from the date on which this notification was dispatched.

**REASONS**

A. The invention(s) in the claim(s) listed below of the subject application should not be granted a patent under the provision of Patent Law Section 29<sup>bis</sup> since it is identical with an invention or device described in the specification or drawings originally attached to the request of the application for patent or utility model registration listed below, which was filed prior to the filing date of the subject application and was laid-open (Kokai) after the filing of the subject application, the inventor of the subject application is not identical with the inventor who has made said invention or device, and the applicant of the subject application is also not identical with the applicant of

said application for patent or utility model registration at the time of filing of the subject application.

Reference [Refer to the list of Cited Reference(s).]

Claim(s) 1 – 9

Cited Reference(s) 1 and 2

B. The invention(s) in the claim(s) listed below of the subject application should not be granted a patent under the provision of Patent Law Section 29(2) since it could have easily been made by persons who have common knowledge in the technical field to which the invention(s) pertains, on the basis of invention(s) described in the publication(s) listed below which was distributed in Japan or foreign countries prior to the filing of the subject application.

Reference [Refer to the list of Cited Reference(s).]

Claim(s) 1 – 9

Cited Reference(s) 3 – 5

Remarks

Cited References 3 through 5 describe the notification of print results, and so on, to the e-mail address of a notification destination node contained in print data.

If any new reason for refusal is found in future, a further notice will be issued.

• Cited Reference(s)

1. Japanese Patent Application No. H6-266875 (Refer to Japanese Laid-Open Patent Publication No. H8-130554)
2. Japanese Patent Application No. H7-208612 (Refer to Japanese Laid-Open Patent Publication No. H9-054731)
3. Japanese Laid-Open Patent Publication No. H5-002541
4. Japanese Laid-Open Patent Publication No. H6-077994
5. Japanese Laid-Open Patent Publication No. H7-175603